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(12) **United States Design Patent** (10) **Patent No.:** **US D905,021 S**  
**Wengreen** (45) **Date of Patent:** **\*\* Dec. 15, 2020**

(54) **MOUNT FOR HEADPHONES**  
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(73) Assignee: **Innovelis, Inc.**, Sammamish, WA (US)  
(\*\*) Term: **15 Years**  
(21) Appl. No.: **29/712,007**  
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(52) **U.S. Cl.**  
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(58) **Field of Classification Search**  
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D6/672, 681, 682, 526; 248/125.1, 166,  
248/185.1; 381/355, 359, 361-363, 365,  
381/366, 369, 375; 379/428.01, 428.04,  
379/431, 433.03  
CPC . H04R 25/00; H04R 1/02; H04R 5/02; H04R  
9/08; F16M 11/38; F16M 13/00; F16M  
11/00  
See application file for complete search history.

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Headphone mount (ASIN B07PFV1N9X) available on Amazon.com prior to Oct. 2019, downloaded on Apr. 1, 2020 from https://www.amazon.com/gp/product/B07PFV1N9X.  
Headphone mount (ASIN B01GJQ7N94) available on Amazon.com prior to Oct. 2019, downloaded on Apr. 1, 2020 from https://www.amazon.com/gp/product/B01GJQ7N94.

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*Primary Examiner* — Katie Jane Stofko

(57) **CLAIM**

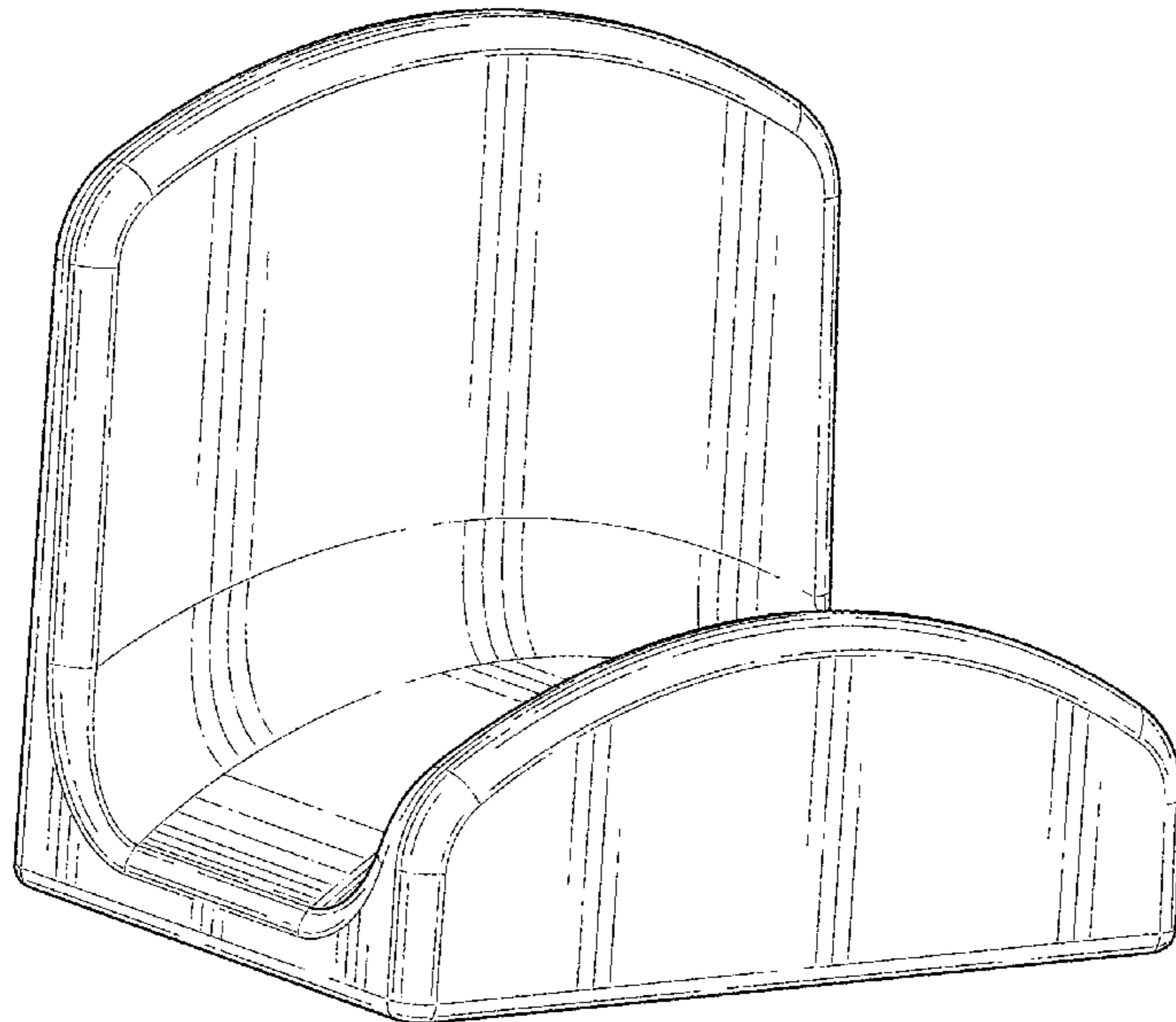
The ornamental design for a mount for headphones, as shown and described.

**DESCRIPTION**

FIG. 1 is a front, left side and top perspective view of a mount for headphones;  
FIG. 2 is a back, right side and bottom perspective view thereof;  
FIG. 3 is a front, left side and bottom perspective view thereof;  
FIG. 4 is a right side elevation view thereof;  
FIG. 5 is a left side elevation view thereof;  
FIG. 6 is a top plan view thereof;  
FIG. 7 is a bottom plan view thereof;  
FIG. 8 is a front elevation view thereof; and,  
FIG. 9 is a back elevation view thereof.  
The broken lines shown in FIGS. 2, 3, 7 and 9 illustrate portions of the mount for headphones that form no part of the claimed design.

**1 Claim, 9 Drawing Sheets**

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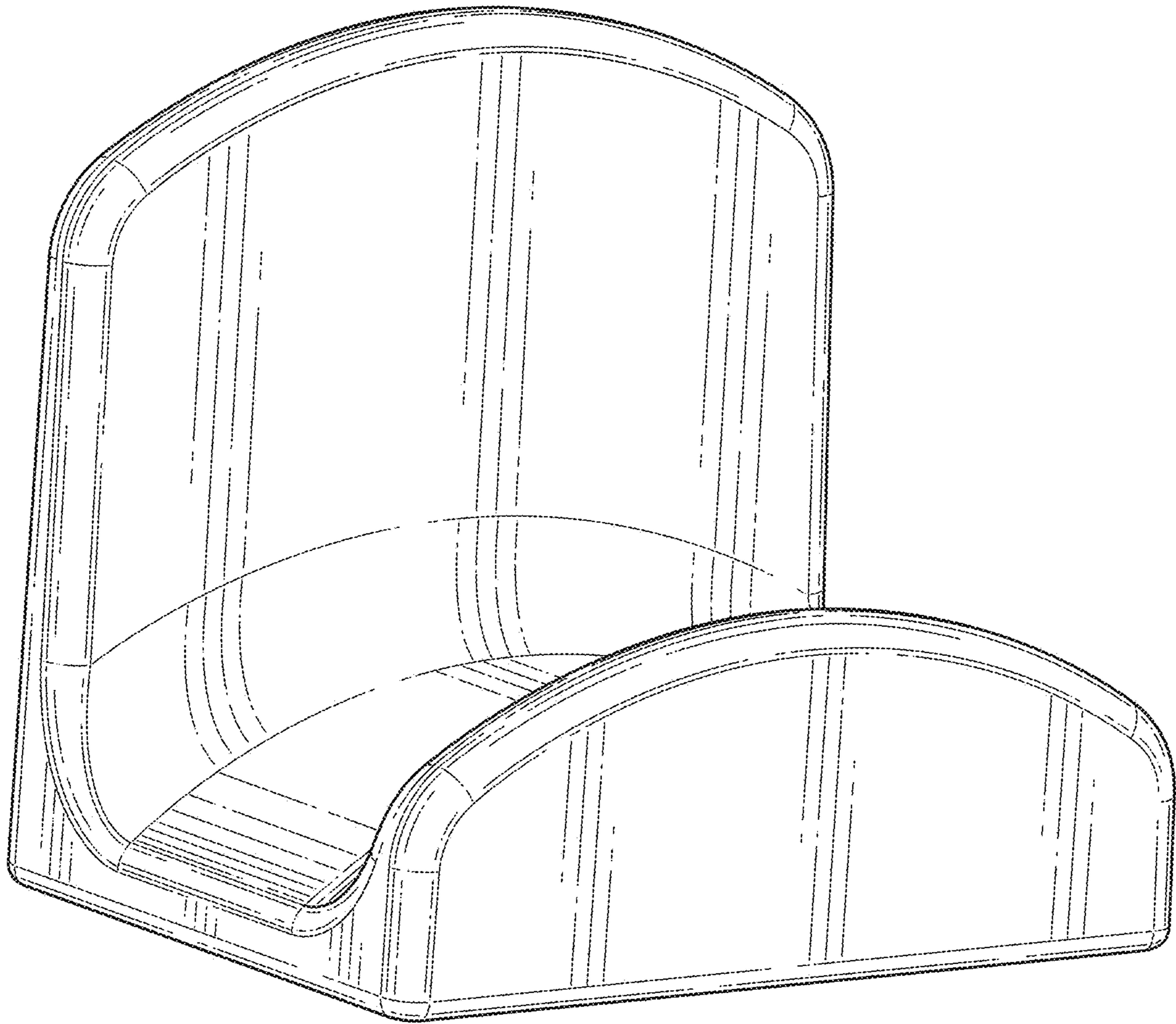


FIG. 1

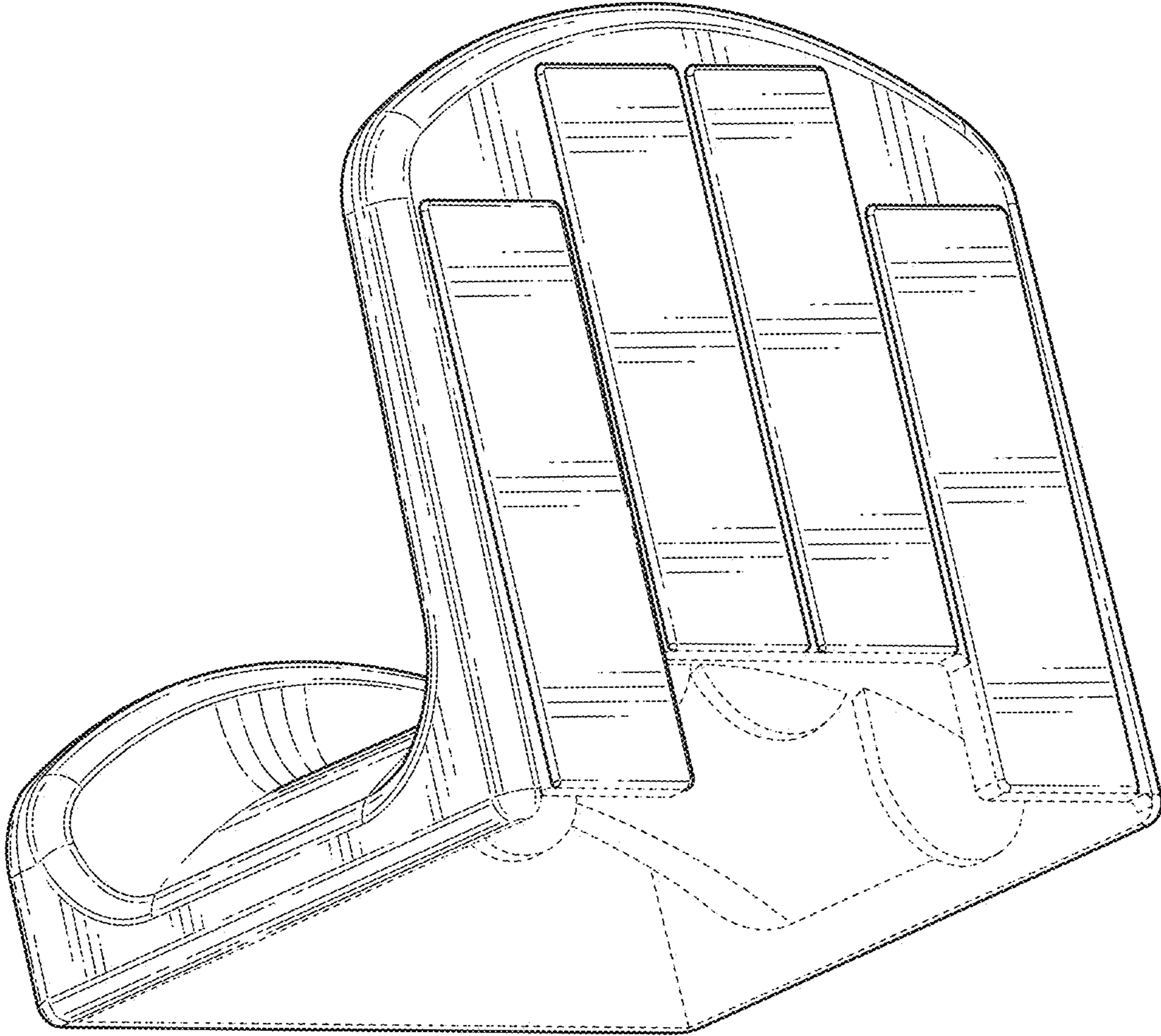


FIG. 2



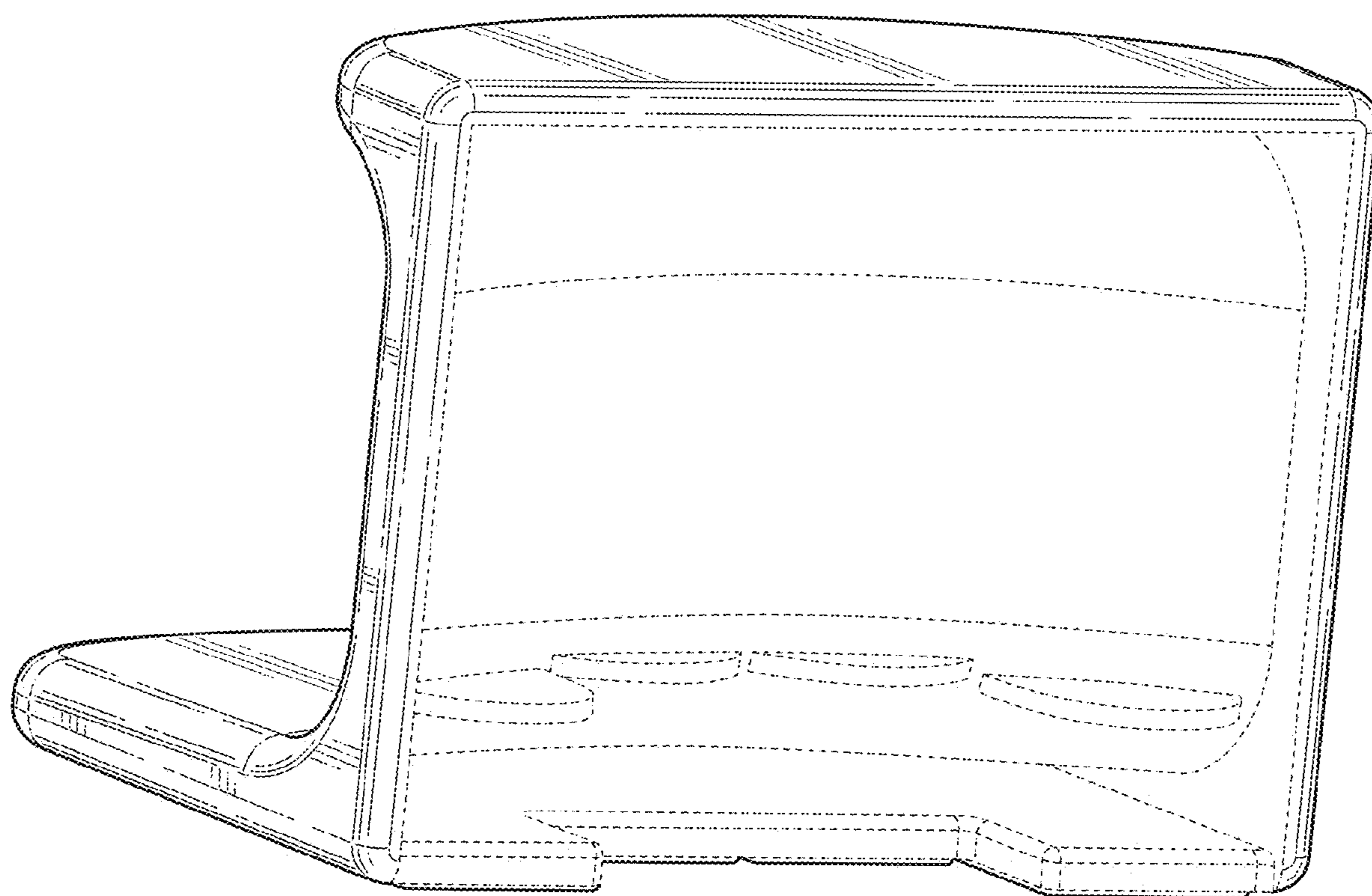


FIG. 3

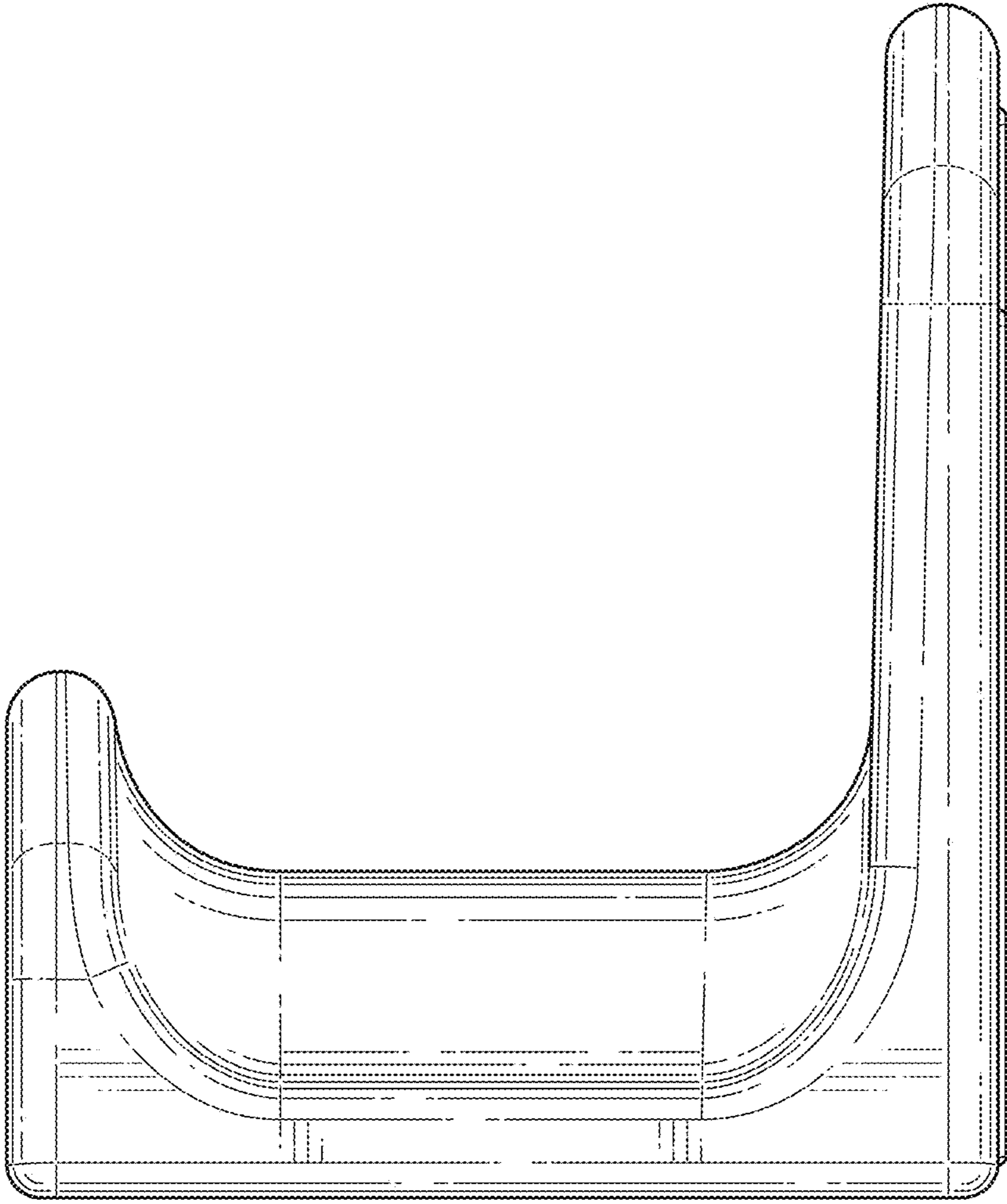


FIG. 4

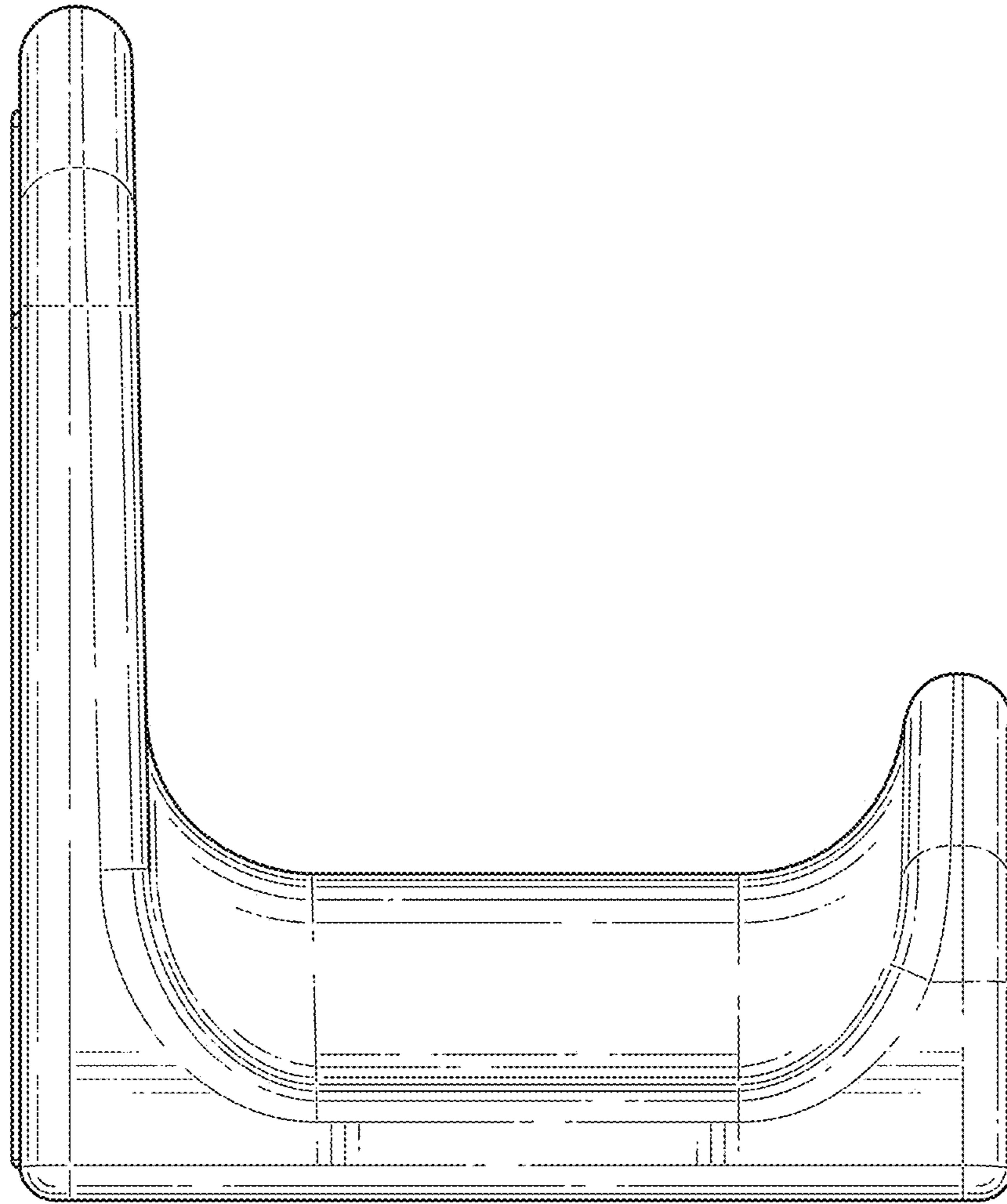


FIG. 5

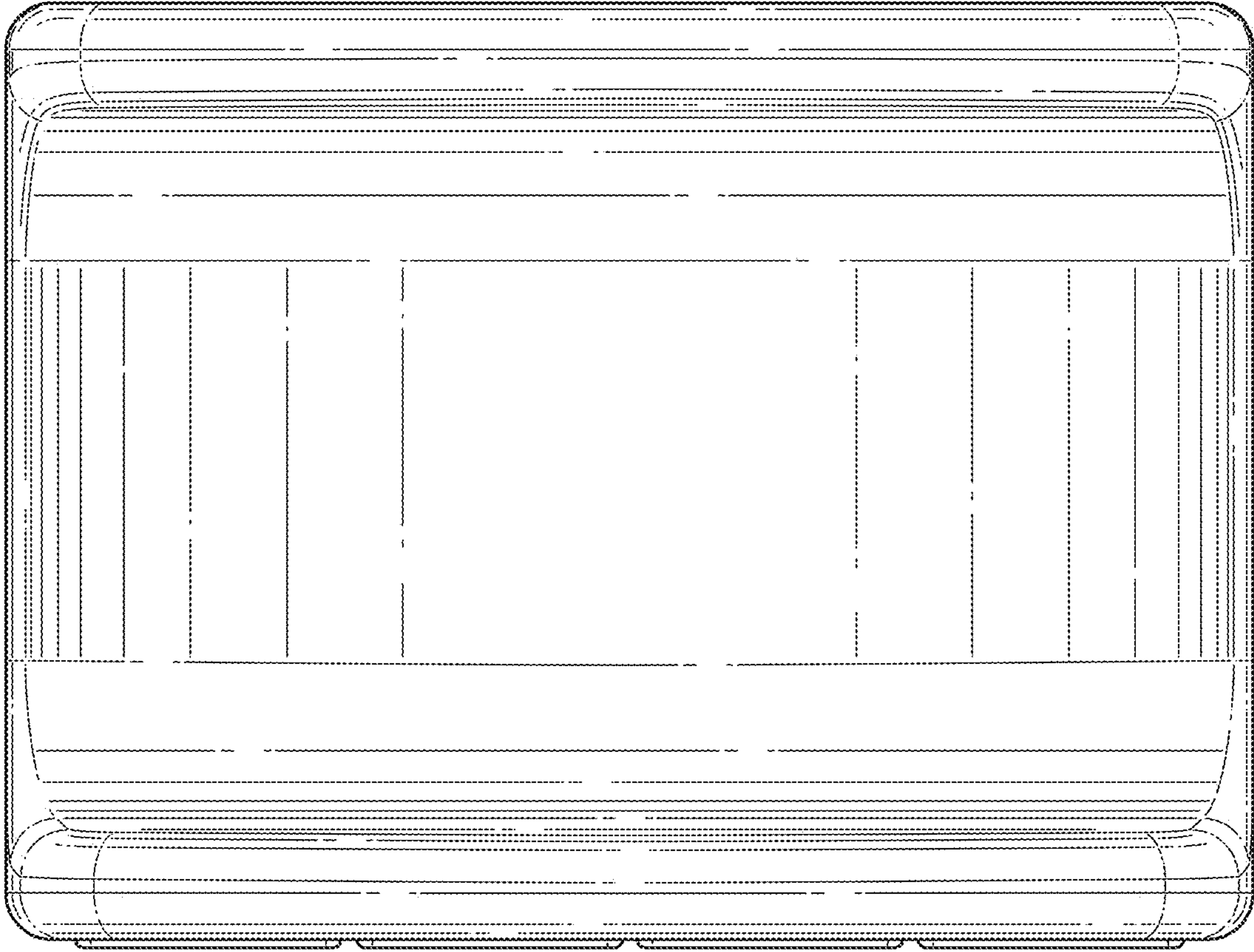


FIG. 6



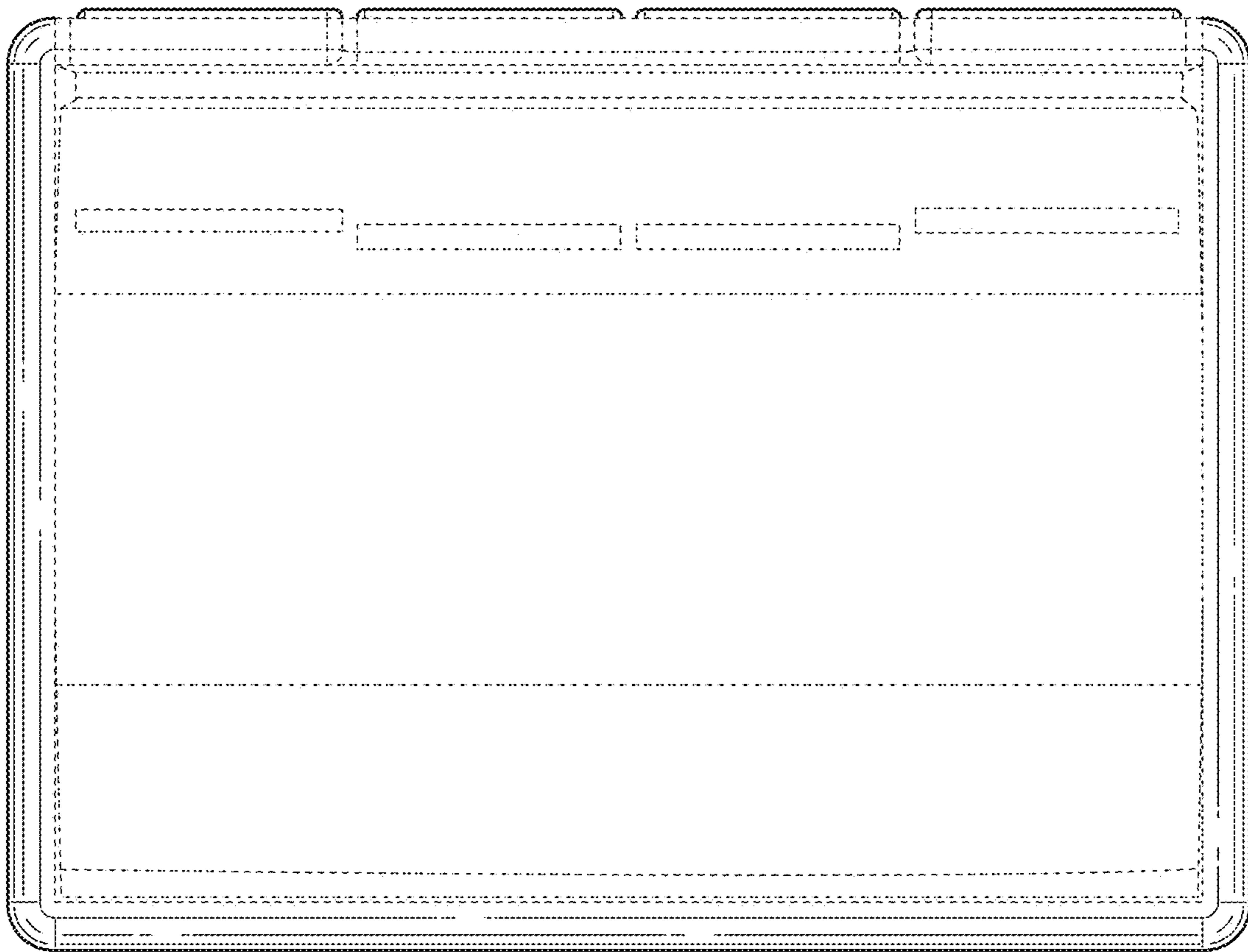


FIG. 7

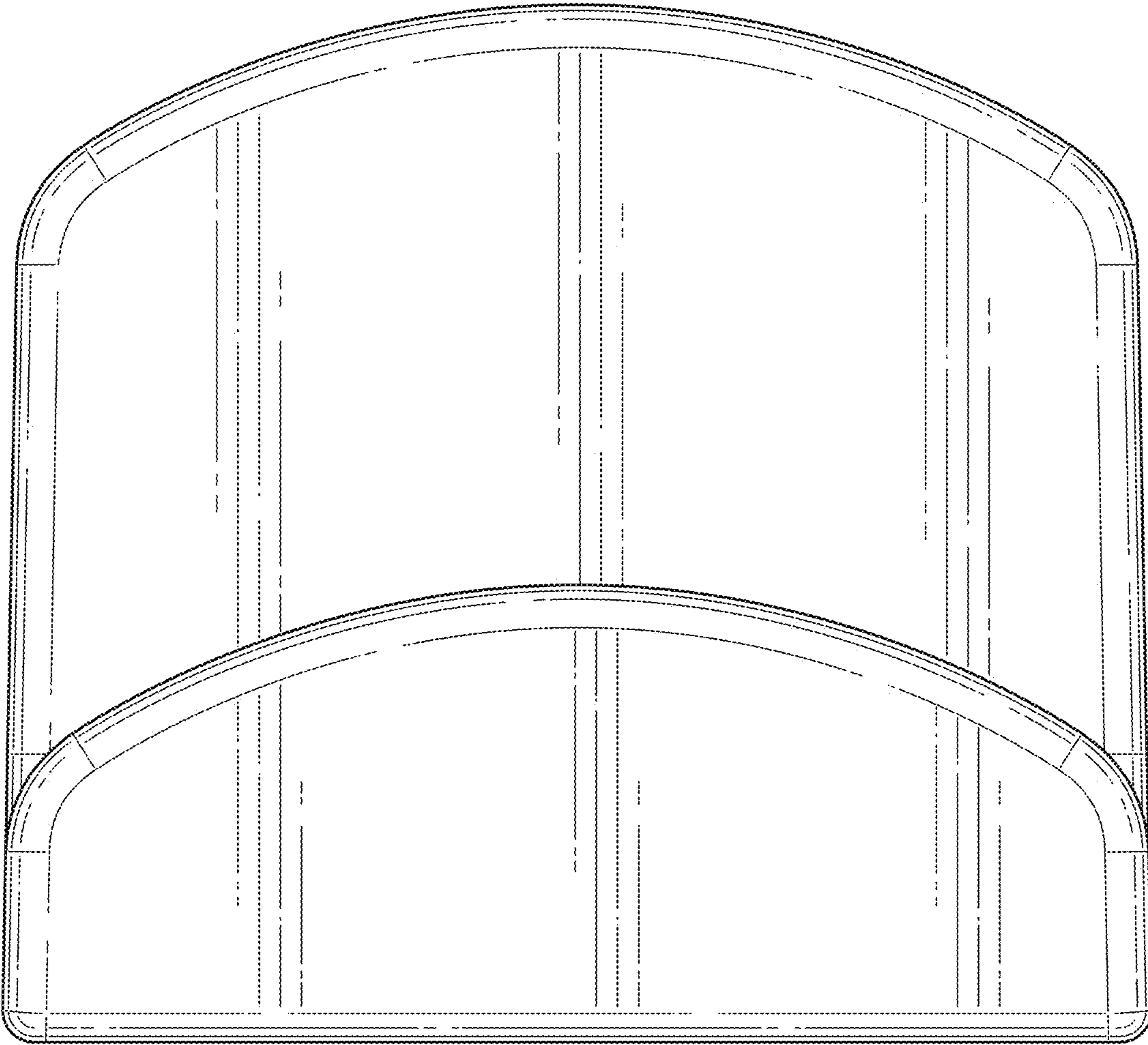


FIG. 8

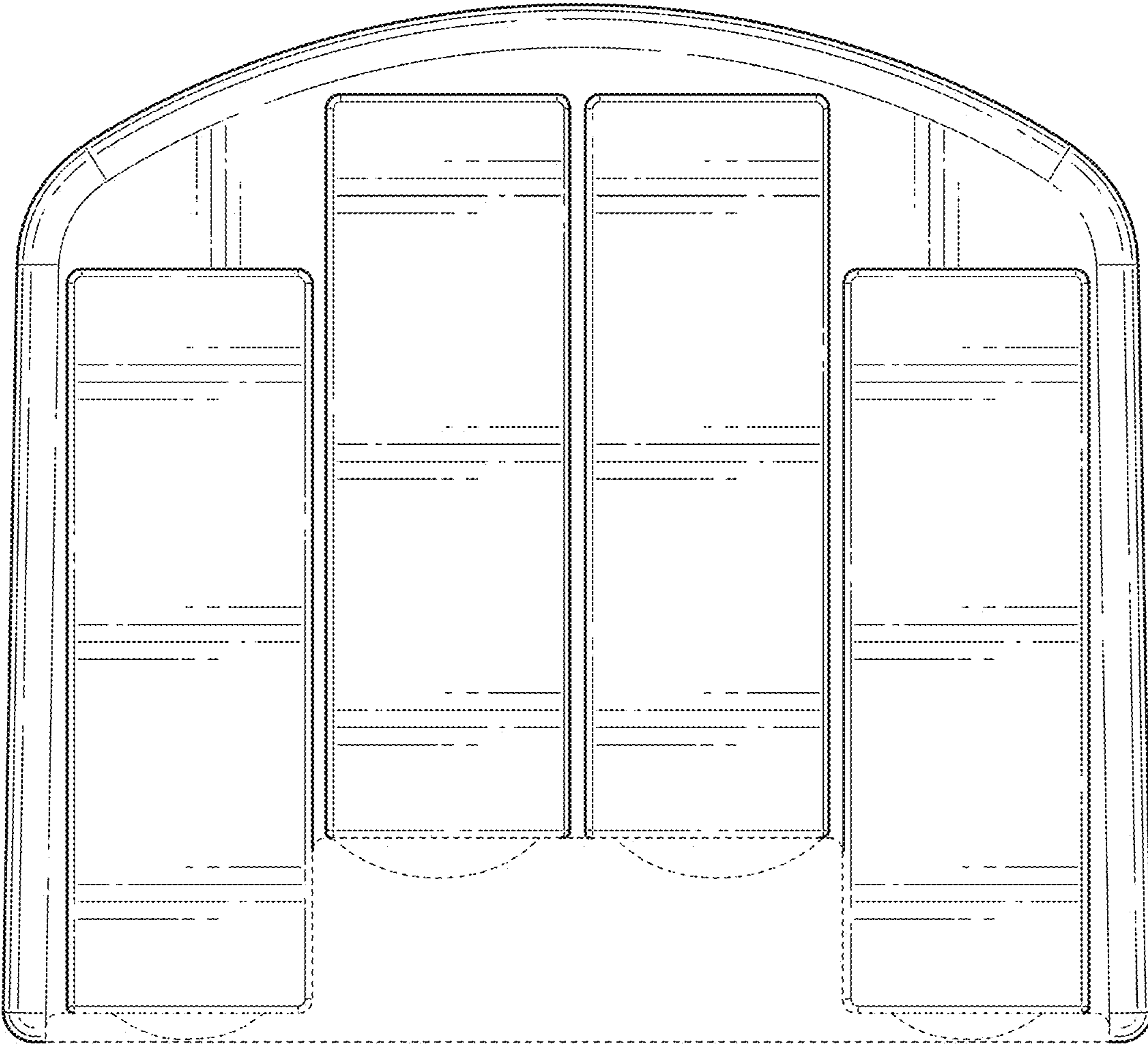


FIG. 9